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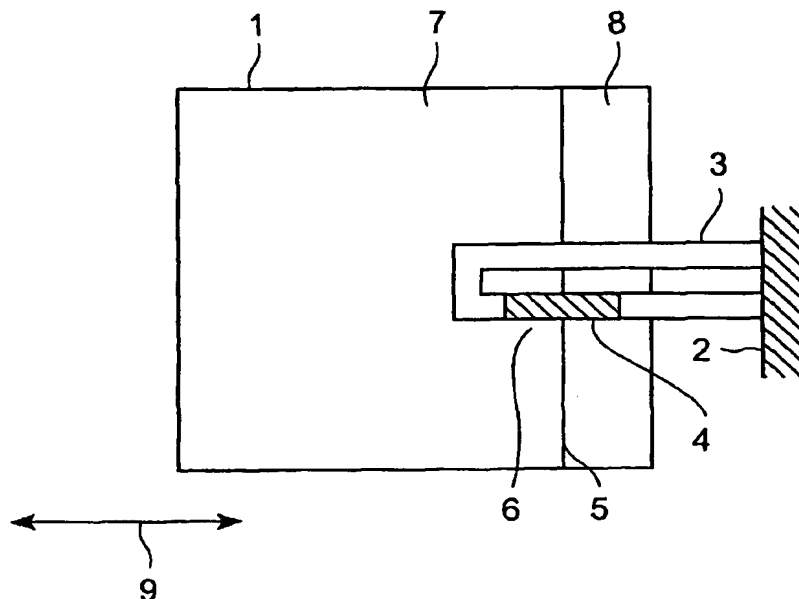
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(54) Title: THERMAL MOVEMENT SENSOR



(57) Abstract: A transducer for detecting movement of an article mounted for movement in a plane, the transducer comprising: a heater facing the plane of movement of the article and having a temperature dependent resistance; and, an edge defined in the article between regions of different thermal conductivity; wherein, as the article describes the movement, the edge moves relative to the heater producing a corresponding variation in heat loss from the heater and a corresponding variation in resistance of the heater.

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THERMAL MOVEMENT SENSOR

The present invention generally relates to transducers for detecting movement of an article and particularly relates to
5 transducers for detecting movement of an article in a Micro-Electro-Mechanical-System (MEMS) device.

An example of typical MEMS device is a local probe storage device as described in Vettiger et al. "The Millipede" - More
10 than one thousand tips for future AFM data storage, P. Vettiger et al, IBM Journal of Research and Development, Vol.44 No.3, May 2000. Such a device typically comprises a storage surface having a locally deformable film disposed thereon and an array of micro mechanical probe sensors each
15 having a probe tip of atomic dimensions facing the coating. In operation, during a data write operation, the tips are brought into proximity to the storage surface. Energy is selectively applied to each tip, typically in the form of heating. The energy applied to the tips is transferred to the storage
20 surface. The energy transfer produces a local deformation in the storage surface in the vicinity of each energized tip. The array of tips is moved in a scanning motion relative to the storage surface between successive write operations in preparation for writing to new locations on the storage
25 surface. During a read operation, the arrays tips are urged against the storage surface. Simultaneously, the tips are again moved in a scanning motion relative to the storage surface. Local deformations of the storage surface produced during the aforementioned write operation produce deflections
30 in the tips as they are scanned over the surface. Such deflections can be detected thermally or optically. The presence or absence of a local deformation in the storage surface by a tip can be detected as a stored "1" or stored "0". The storage surface is mounted on an X-Y scanner to
35 facilitate the scanning motions associated with the aforementioned reading and writing operations.

In operation, position error signals (PES) encoded in the storage surface facilitate sensing of the position and velocity of the storage surface relative to the tips. However, the PES data may be unavailable in some circumstances, such as
5 upon initial start up of the device or during recovery of the device from a mechanical shock. To acquire the PES data, the scanner is first moved to a specified location and then scanning at a specified velocity is begun. However, to simplify such acquisition, it would be desirable to provide a
10 transducer for movement sensing independently of the PES data in circumstances when the encoded PES signal is not available.

In accordance with the present invention, there is now
15 provided a transducer for detecting movement of an article mounted for movement in a plane, the transducer comprising: a heater facing the plane of movement of the article and having a temperature dependent resistance; and, an edge defined in the article between regions of different thermal conductivity;
20 wherein, as the article describes the movement, the edge moves relative to the heater producing a corresponding variation in heat loss from the heater and a corresponding variation in resistance of the heater.

25 The article may be mounted for translational movement in the plane. Alternatively, the article may be mounted for rotational movement in the plane. However, initially focussing on the translational case, the edge is preferably located in a plane surface of the article. In particularly preferred
30 embodiments of the present invention, the edge is rectilinear. In a particularly preferred embodiment of the present invention, the heater preferably comprises an elongate body overlapping and extending parallel to the plane surface and perpendicular to the edge. This advantageously provides a
35 surprisingly linear response to displacement of the article. Furthermore, in MEMS embodiments of the present invention to be described shortly, the response is surprisingly fast, thus allowing the use of relatively high bandwidth feedback for a

range of servo control applications. The elongate body preferably comprises a silicon cantilever having a doped resistive region formed therein. The transducer technology of the present invention is thus conveniently compatible with
5 other MEMS fabrication technologies. The edge may be located on the periphery of the plane surface. Alternatively, the edge is formed as a step in the plane surface.

The present invention also extends to a movement detection
10 system for detecting movement of an article mounted for movement in a plane, the system comprising: first and second transducers as herein before described operative in opposite directions along a common axis of movement of the article in the plane. Preferably, the first and second transducers
15 respectively face first and second parallel edges of the surface.

The present invention also extends to a movement detection system for detecting movement of an article mounted for
20 movement in a plane, the system comprising: first and second transducers as herein before described operative in orthogonal directions of movement of the article in the plane. Preferably, in this instance, the first and second transducers respectively face first and second orthogonal edges of the
25 surface. This arrangement advantageously facilitates measurement of displacements in two orthogonal directions independently without cross talk between the transducers.

In another embodiment of the present invention, the surface is
30 mounted for rotational movement parallel to the heater about an axis of rotation. The edge may be in the form of a side of a slot formed in the surface and extending radially from the axis of the rotation. Alternatively, the surface may comprise a spoke extending radially from the axis of rotation and the
35 edge comprises a side of the spoke.

Viewing the present invention from another aspect, there is now provided a method for detecting movement of an article

mounted for movement in a plane, the method comprising:
locating a heater having a temperature dependent resistance to
face the plane of movement of the article; defining an edge in
the article between regions of different thermal conductivity;
5 and, detecting variation in resistance of the heater
corresponding to variation in heat loss from the heater as the
edge moves relative to heater during movement of the article
in the plane.

10 Viewing the present invention from yet another aspect, there
is now provided a local probe storage device comprising:
storage surface, local probe storage array having a plurality
of tips facing the storage surface; a scanner for moving the
storage surface relative to the array in a plane parallel to
15 the array; and a movement detection system as herein before
described for detecting movement of the storage surface
relative to the array.

This advantageously facilitates a stiffer scanner subassembly
20 without sacrificing sensitivity. A sensitivity better than the
pitch of data tracks on the storage surface, typically around
80 nm, permits start up and seek operations to a specified
data track in reduced access times.

25 Preferred embodiments of the present invention will now
described, by way of example only, with reference to the
accompanying drawings, in which:

Figure 1 is a plan view of an example of transducer embodying
30 the present invention;

Figure 2 is a plan view of another example of a transducer
embodying the present invention;

35 Figure 3 is a graph of resistance of a heater of the
transducer shown in shown in Figure 2 against time;

Figure 4 is a plan view of yet another example of a transducer embodying the present invention;

Figure 5 is a side view of the transducer shown in Figure 4;

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Figure 6 is another side view of the transducer shown in Figure 4;

Figure 7 is yet another side view of the transducer shown in

10 Figure 4;

Figure 8 is a scanning electron microscope (SEM) micrograph of a preferred example of transducer embodying the present invention in plan view;

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Figure 9 is a magnification of the SEM micrograph shown in Figure 8;

Figure 10 is a graph of change in sensor voltage versus time for an example of a transducer embodying the present invention;

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Figure 11 is another graph of change in sensor voltage versus time for an example of a transducer embodying the present invention;

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Figure 12 is a block diagram of circuitry for obtaining displacement, velocity, and acceleration measurements from a transducer embodying the present invention;

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Figure 13 is a simplified circuit diagram of circuitry for obtaining displacement, velocity, and acceleration measurements from a transducer embodying the present invention;

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Figure 14 is a plan view of an example of another transducer embodying the present invention;

Figure 15 is a side view of the transducer shown in Figure 14;

Figure 16 is another side view of the transducer shown in Figure 14;

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Figure 17 is a plan view of another transducer embodying the present invention;

Figure 18 is yet another side view of a transducer embodying
10 the present invention;

Figure 19 is a plan view of yet another transducer embodying the present invention;

15 Figure 20 is a plan view of a further transducer embodying the present invention;

Figure 21 is a plan view of yet another example of a transducer embodying the present invention;

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Figure 22 is a graph of resistance of a heater of the transducer shown in shown in Figure 21 against time;

Figure 23 is a plan view of a further example of a transducer
25 embodying the present invention;

Figure 24 is another graph of resistance of a heater of the transducer shown in shown in Figure 23 against time;

30 Figure 25 is yet another graph of resistance of a heater of the transducer shown in shown in Figure 23 against time;

Figure 26 is a further graph of resistance of a heater of the transducer shown in shown in Figure 23 against time; and,

35

Figure 27 is a side view of a local probe storage device embodying the present invention.

Referring first to Figure 1, in a preferred embodiment of the present invention, there is provided a transducer 3 for detecting movement of an article 1 mounted for translational movement in a plane along an axis of travel 9 in either
5 direction relative to reference 2. The transducer 3 comprises a heater 4 facing the plane of movement of the article 1. The heater 4 has a temperature dependent resistance. The article 1 comprises a surface 6 having a first region 7 and a second region 8. The thermal conductivity of the first region 7 is
10 different to that of the second region 8. An edge 5 separates the first region 7 from the second region 8. The edge 5 thus acts as a boundary between regions of greater and lesser thermal conductivity. In operation, as the article 1 is moved
15 along the axis of travel 9, the edge 5 moves relative to the heater 4 producing a corresponding variation in heat loss from the heater 4 and a corresponding variation in resistance of the heater 4.

Referring now to Figure 2, in another embodiment of the
20 present invention, there is provided a transducer 3 for detecting movement of an article 1 mounted for rotational movement in a plane about an axis of rotation in either direction. The article 1 is in the form of a rotatable disk, shaft, or spindle. The transducer 3 again comprises a heater 4
25 facing the plane of rotation of the article 1. Again, the heater 4 has a temperature dependent resistance. The article 1 comprises a surface 6 having a first region 7 and a second region 8. The thermal conductivity of the first region 7 is again different to that of the second region 8. Again, an edge
30 5 separates the first region 12 from the second region 14. The edge 5 thus acts as a boundary between regions of greater and lesser thermal conductivity. In operation, as the article 1 is rotated, the edge 5 moves relative to the heater 4 producing a
35 corresponding variation in heat loss from the heater 4 and a corresponding variation in resistance of the heater 4.

Referring to Figure 3, as the article 1 rotates, the resistance of the heater 4 follows a pulse wave form, with

each pulse corresponding to an instance of the second region 8 passing the heater 4.

The difference in thermal conductivity between the first region 7 and the second region 8 may be implemented in many ways. For example, the second region 8 may be formed from or otherwise coated with a material having different thermal properties from those of the material from which the first region 7 is formed. Alternatively or additionally, one of the first and second regions may be perforated with pores or apertures thereby locally modifying the thermal properties of bulk material. In particularly preferred embodiments of the present invention, the second region 8 is constituted by an air gap. Such an air gap may be constituted by introducing a recess into the surface 6, with edge 5 being in the form of a step. Alternatively, in particularly preferred embodiments of the present invention to be described shortly, the air gap may be provided by free space at the periphery of the surface 6, with the edge 5 being a peripheral edge of the surface 6.

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Differences in thermal conductivity become significant on the micro meter or nano meter scale of especially preferred embodiments of the present invention. Turning to Figure 4 for example, in a preferred embodiment of the present invention, there is provided a transducer 3 as herein before described with reference to Figure 1 for measuring the nano-meter scale linear movement of an article 1. The transducer 3 is formed from silicon. However, it will be appreciated that in other embodiments of the present invention, different materials may be employed in place of silicon. The transducer 3 is positioned in proximity to but spaced from an peripheral edge 5 of a surface 6 of the article 1, such that the first region 7 is formed from the bulk material of the surface 6 and the second region 8 is formed from air or gas surrounding the article 1. The transducer 3 comprises an elongate body extending from the reference 2 in a direction perpendicular to the edge 5 of the surface 6 and parallel to the surface 6. The body of the transducer 3 carries an electrically conductive

path for carrying an electrical current. The conductive path may be formed by doping the silicon body of the transducer 3 with suitable charge donors or acceptors. Other techniques for introducing the conductive path will be apparent to those skilled in the art. The body of the transducer 3 comprises a pair of limbs terminating in an interconnection remote from the reference. It will be appreciated however that other designs for the body of the transducer 3 are equally possible. A thermally isolated electrically resistive heater element 4 is disposed on the body in the electrically conductive path. The heater 4 may be again formed by doping the silicon body with suitable donors or acceptors. Other techniques for introducing the heater 4 will be apparent to those skilled in the art. The heater 4 is positioned on the body of the sensor 3 such that the edge 5 of the surface 6 is located along the length of the heater 4. The heater 4 is at least as long as the desired displacement range of the article 1 and aligned with its longitudinal axis parallel to the direction of motion to be sensed.

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In operation, a current is passed through the heater 4. The current flow causes heat generation in the heater 4. The resistance of the heater 4 is dependent on the temperature of the heater 4. The temperature of the heater 4 is dependent on the distance between the heater 4 and the surface 6.

Accordingly, the temperature of the heater 4 is dependent of the position of the heater 4 relative to the surface 6. More specifically, the temperature of the heater 4 is dependent on the level of overlap between the heater 4 and the surface 6. The relationship between the temperature of the heater 4 and the surface 6 stems from conduction of heat energy from the heater 4 to the surface 6 through the intervening gap.

The efficiency of such conduction is dependent on the distance between the heater 4 and the surface 6. When the surface 6 is displaced in a direction parallel to the longitudinal axis of the sensor 3, the average distance from the heater 4 to the surface 6 is increased or decreased by virtue of the edge 5

formed on the surface 6. An increase or decrease in this distance produces a corresponding change in cooling efficiency of the heater 4. The change in cooling efficiency produces a corresponding change in resistance of the heater 4. In especially preferred embodiments of the present invention, the edge 5 of the surface 6 adjacent the heater 4 is both smooth and perpendicular to the direction of motion to be sensed such that any motion in this perpendicular direction produces no change in cooling efficiency and therefore no signal. Similarly, in particularly preferred embodiments of the present invention, the plane of the heater 4 is parallel to the plane of the surface 6 to provide an output signal which varies as a linear function of displacement of the article 1. The sensitivity of the transducer 3 is dependent on the spacing between the heater 4 and the surface 6.

Referring to Figures 5, 6 and 7, it will be appreciated that the areas of the surface 6 and the heater 4 overlapping or in other words facing each other vary as the article 1 is moved relative to the reference 2. For example, in Figure 5, approximately half of the heater is facing the surface 6, corresponding to the transducer 3 being close to the middle of its range. In Figure 6, the transducer 3 is at one extremity of its range, with a minimal area of the heater 4 facing the surface 6. Motion of the surface 6 towards this extremity results in a decrease in cooling of the heater 4. The temperature of the heater 4 is therefore increased. The increase in temperature is measured as a change in resistance of the heater 4. Conversely, in Figure 7, the transducer 3 is at the other extremity of its range, with near to the full area of the heater 4 facing the surface 6. Motion of the surface 6 towards this extremity results in an increase in cooling of the heater 4. The temperature of the heater 4 is therefore decreased. The decrease in temperature is again measured as a change in resistance of the heater 4.

Remaining with Figures 5, 6, and 7, in particularly preferred embodiments of the present invention, this spacing is defined

by at least one tip 10 disposed at the end of the transducer 3 overlying the surface 6. The or each tip 10 is in sliding contact with the surface 6. In operation, the or each tip 10 facilitates well defined spacing of the transducer 3 relative to the surface 6 while maintaining thermal isolation of the heater 4 relative to the surface 6. With reference to Figures 7 and 8 in combination, in a particularly preferred embodiment of the present invention, the transducer 3 herein before described is fabricated from a silicon substrate in the form of a cantilever spring extending by around 150 micro meters from the reference 2. The cantilever spring comprises a pair of limbs interconnected in a termination remote from the reference 2. The conduction path passes along one limb, through the termination, and then along the other limb. The heater 4 is located in one of the limbs. An aperture 11 is formed in the limb carrying the heater 4 at each end of the heater 4. The apertures 11 introduce constrictions in the thermal conduction path between the heater 4 and the rest of the transducer 3, thereby thermally isolating the heater 4. Dopant implantation of the host limb is employed in this instance to produce the heater 4. However, in other embodiments of the present invention, the heater 4 may be produced by other techniques.

In especially preferred embodiments of the present invention, the transducer 3 is made resistant to torsional forces in the interests of minimizing twisting of the transducer 3 by friction between the or each tip 10 and the surface 6. Such twisting may otherwise adversely affect the linearity of the transducer 3. The twin limb design of the transducer 3 described with reference to Figures 8 and 9 assists in offering torsional resistance. Note that in the preferred embodiments shown in Figures 8 and 9, a pair of the aforementioned tips 10 are positioned near to opposite corners of the termination of the transducer 3. By positioning a pair of such tips 10 in this manner, additional stability and reduced sensitivity to torsional motion in the transducer 3 is obtained.

Figures 10 and 11 illustrate measurements of sensitivity and linearity of the transducer 3 herein before described with reference to Figures 8 and 9. The measurements were performed with the tips 10 of the transducer 3 in contact with a sample surface of silicon in an arrangement similar to that herein before described with reference to Figures 4 to 7. The measurements were obtained by applying a direct current (DC) voltage across the transducer 3 in series with a 10kOhm resistor and monitoring voltages changes across the transducer 3 as the sample table was displaced in a periodic linear motion following a triangular wave form. The voltage changes were observed via a DC coupled amplifier with a gain of 100 and a bandwidth of 100kHz. The graph of Figure 7 shows the detected signal resulting from a 40nm displacement of the surface 6. Apparent from Figure 10 is a sensitivity in the transducer 3 of less then 40nm in a 100kHz bandwidth with a signal to noise ratio of approximately 1. The graph of Figure 11 shows the response of the transducer 3 to a 37 micro meter periodic linear displacement of a triangular wave form). Specifically, the graph of Figure 11 demonstrates that the transducer 3 has a linear response over a range of more then 25 micro meters. In the region in which the response of the transducer 3 to displacement is substantially linear, the velocity and acceleration of the surface 6 can be calculated by taking the first and second derivatives of the voltage signal. The deviation from linearity observed below -0.5V on the y axis results from an angular misalignment between the transducer 3 relative to the plane of the surface 6. The thermal time constant of this particular example of the present invention with the tips 10 in contact with the surface 6 was measured to be in the region 50 microseconds. Other embodiments of the present invention may exhibit different thermal time constants.

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As indicated earlier, the velocity and acceleration of the surface 6 can be calculated by taking the first and second derivatives of the voltage signal from the transducer 3.

Referring now Figure 12, in a preferred embodiment of the present invention, the first and second derivatives of the voltage signal from the transducer 3 are obtained by connecting first and second differentiator circuits 12 and 13 in series to the output of the transducer 3. In operation, the output of the transducer 3 produces a signal indicative of the sensed displacement d , the output of the first differentiator circuit 12 produces a signal indicative of the sensed velocity v , and the output of the second differentiator circuit 13 produces a signal indicative of the sensed acceleration a . Referring to Figure 13, the first differentiator circuit 12 may be formed from a capacitor $C1$, resistor $R1$, and virtual earth amplifier $A1$ having a negative feedback loop including $R1$. Similarly, the second differentiator 13 may be formed from a capacitor $C2$, resistor $R2$, and virtual earth amplifier $A2$ having a negative feedback loop including $R2$. It will be appreciated that other differentiator circuit designs are also possible.

In some environments, changes in ambient temperature and the like may give rise to undesirable DC drift in measurements obtained from a transducer 3 of the form herein before described. Such changes unsuitable for some applications. However, referring now to Figure 14, in an especially preferred embodiment of the present invention, sensitivity to DC drift is minimized by employing a pair of transducers 3 and 3' as herein before described. Specifically, the transducers 3 and 3' are placed adjacent opposite edges 5 and 5' of the surface 6. The difference in output voltages from the transducers 3 and 3' is then measured. In Figure 15, the surface 6 is positioned close to the midpoint of the range of the transducers 3 and 3'. Accordingly, the surface 6 is facing approximately equal areas of the transducers 3 and 3'. However, in Figure 16 the surface 6 is displaced along the axis of detection of the transducers 3 and 3' to one extremity of the range of the transducers 3 and 3'. Accordingly, almost all of one transducer 3' is facing the surface 6 while almost none of the other transducer 3 is facing the surface 6.

In the preferred embodiments of the present invention herein before described a transducer 3 is provided for measuring displacement of an article along a single axis of motion.

5 However, the present invention is equally applicable to measuring linear movement of an article 1 along more than one axis of motion. For example, referring now to Figure 17, in another preferred embodiment of the present invention, there is provided two transducers 3 and 3'' as herein before
10 described with reference to Figures 1 to 10 each measuring displacement of an article 1 in a corresponding one of two orthogonal directions. Specifically, one of the transducers 3 is positioned adjacent a first edge 5 of the surface 6. The other transducer 3'' is positioned adjacent a second edge 5''
15 of the surface 6 orthogonal to the first edge 5. Each of the transducers 3 and 3'' thus provides a movement measurement corresponding to linear movement of the surface 6 along a different one of two orthogonal axis of movement of the surface 6. The independent operation of the two transducers 3
20 and 3'' prevents cross talk between the two measurements.

In some of the preferred embodiments of the present invention herein before described, the edge 5 of the surface 6 is provided by the periphery of the surface. However, referring
25 to Figure 18, in other embodiments of the present invention, the edge 5 may, as indicated earlier, be provided by a step formed in the surface 6. Other formations of the edge 5 are also possible, such as slots in the surface 6 and the like.

30 As indicated earlier, with reference to Figure 2, the present invention is equally applicable to detection of rotational movement. Referring to Figure 19, in a modification of the embodiment of the present invention shown in Figure 2, the second region 8 is constituted by a radial slot 9 formed in
35 the disk 6. A transducer 3 as herein before described with reference to Figures 1 to 10 is disposed adjacent the disk 6 in a plane parallel to the disk 6 such that the slot 9 passes the heater 4 as the disk 6 rotates. Thermal conduction between

the heater 4 and the disk 6 is disturbed each time the slot 9 passes the heater 4. As indicated earlier, these disturbances can be detected electrically from the heater 4. A pulse signal indicative of the rate of rotation of the shaft 1 can thus be generated. It will be appreciated then that this embodiment of the present of the invention is particularly although not exclusively useful in tachometer applications. In another modification of the preferred embodiment shown in Figure 18 a plurality of equidistantly spaced radial slots 9 are formed in the disk 6. The slots 9 facilitate measurement of rotary displacement of the shaft 1. It will be appreciated that, in other embodiments of the present invention, the slots 9 may be replaced by recesses formed in the disk 6. Referring to Figure 20, in another modification of the present invention herein before described with reference to Figure 19, the surface 6 is in the form of a spoke extending radially from the shaft 1. Thermal conduction from the heater 4 is disturbed each time the spoke 6 passes the heater 4. Again then, a pulse signal indicative of the rate of rotation of the shaft 1 can be generated electrically from the heater 4. It will be appreciated that a plurality of radial spokes 6 may be connected to the shaft 1 to facilitate measurement of rotary displacement of the shaft 1.

Referring now to Figure 21, in another embodiment of the present invention for detecting rotation of a shaft 1, the first region 7 is provided by a comma-shaped surface attached to the shaft 1 and the second region 8 is provided by the air surrounding the surface. The edge 5 between the first region 7 and the second region 8 is provided by the periphery of the surface. The surface is shaped such that the radial distance between the axis of rotation of the periphery of surface increases from a minimum to a maximum along the periphery of the surface. The transducer 3 is disposed adjacent the surface as herein before described with reference to 19. Referring to Figure 22, as the shaft rotates, the resistance of the heater 4 follows a swath wave form.

Referring to Figure 23, in yet another embodiment of the present invention for detecting rotation of the shaft, the first region is provide by a disk-shaped surface attached to the shaft 1 and the second region 8 is provided by the air 5 surrounding the surface. The edge between the first region 7 and the second region 8 is provided by the periphery of the disc. A pair of transducers 3 and 3' as herein before described face opposite edges of the disc. The axis of rotation of the shaft 1 is offset relative to the center of 10 the disc. Referring to Figure 24, as the shaft rotates, the resistance of the In operation, the resistance of the heater 4 on one of the transducers 3 follows a triangular wave form. Similarly, referring to Figure 25, as the shaft rotates, the resistance of the heater 4' on the other transducer 3' follows 15 a triangular wave form. However, the triangular wave form associated with the resistance of heater 4' is 90 degrees out of phase from the triangular wave form associated with the resistance of heater 4. Referring to Figure 26, a composite output from the transducers 3 and 3', in which any DC offset 20 in the detected signals is removed, can be created by subtracting the output from one of the heaters 4 and 4' from the other.

With reference to Figure 27, transducers 3 and 3' embodying 25 the present invention herein before described with reference to Figures 8 and 9 are particularly useful for measuring the movement of an article 1 relative to a reference 2 such as a storage surface 15 relative to the local probe array 14 in a local probe storage device 18 as described in the 30 aforementioned Vettiger et al. document. As indicated earlier, in a local probe storage device 18, the storage surface 15 is typically moved in orthogonal directions within a plane parallel to the array 14 via a micro mechanical scanner subsystem 16. The scanner subsystem 16 may implemented by 35 piezoelectric devices. However, other scanning mechanisms are possible. A controller 17 is connected to the scanner 16 and the transducers 3. Two cooperating pairs of transducers 3 each as herein before described with reference to Figure 13 are

provided. One of the pairs of transducers 3 detects movement in one of the orthogonal directions of travel. The other pair of transducers 3 detects movement in the other direction of travel. The outputs from the transducers 3 are fed to the controller 17 to complete a negative feedback control loop for controlling movement of the array 14 relative to the storage surface 15, particularly in circumstances where the aforementioned PES signal has yet to be acquired or reacquired. The controller may be implemented in hard wired circuitry, computer program code, or by a combination of hard wired circuitry and computer program code. It will be appreciated that the present invention is equally useful in many other applications. Examples of such applications include displacement sensors, velocity sensors, and accelerometers for automotive control systems and actuators and industrial plant control systems. Many other applications will be apparent.

CLAIMS

1. A transducer for detecting movement of an article mounted
for movement in a plane, the transducer comprising: a heater
5 facing the plane of movement of the article and having a
temperature dependent resistance; and, an edge defined in the
article between regions of different thermal conductivity;
wherein, as the article describes the movement, the edge moves
relative to the heater producing a corresponding variation in
10 heat loss from the heater and a corresponding variation in
resistance of the heater.

2. A transducer as claimed in claim 1, wherein the article
is mounted for translational movement in the plane.

15

3. A transducer as claimed in claim 2, wherein the edge is
located in a plane surface of the article.

4. A transducer as claimed in claim 3, wherein the edge is
20 rectilinear.

5. A transducer as claimed in claim 4, wherein the heater
comprises an elongate body overlapping and extending parallel
to the plane surface and perpendicular to the edge.

25

6. A transducer as claimed in claim 5, wherein the elongate
body comprises a silicon cantilever having a doped resistive
region formed therein.

30 7. A transducer as claimed in claim 5 or claim 6, wherein
the edge is located on the periphery of the plane surface.

8. A transducer as claimed in claim 5 or claim 6, wherein
the edge is formed as a step in the plane surface.

35

9. A movement detection system for detecting movement of an
article mounted for movement in a plane, the system

comprising: first and second transducers as claimed in any of claims 5 to 8 operative in opposite directions along a common axis of movement of the article in the plane.

5 10. A movement detection system as claimed in claim 9, wherein the first and second transducers respectively face first and second parallel edges of the surface.

11. A movement detection system for detecting movement of an
10 article mounted for movement in a plane, the system comprising: first and second transducers as claimed in any of claims 5 to 8 operative in orthogonal directions of movement of the article in the plane.

15 12. A movement detection system as claimed in claim 11, wherein the first and second transducers respectively face first and second orthogonal edges of the surface.

13. A local probe storage device comprising: storage surface,
20 local probe storage array having a plurality of tips facing the storage surface; a scanner for moving the storage surface relative to the array in a plane parallel to the array; and a movement detection system as claimed in any of claims 9 to 12 for detecting movement of the storage surface relative to the
25 array.

14. A transducer as claimed in claim 1, wherein the surface is mounted for rotational movement parallel to the heater about an axis of rotation.

30

15. A transducer as claimed in claim 14, wherein the edge is in the form of a side of a slot formed in the surface and extending radially from the axis of the rotation.

35 16. A transducer as claimed in claim 14, wherein the surface comprises a spoke extending radially from the axis of rotation and the edge comprises a side of the spoke.

17. A method for detecting movement of an article mounted for movement in a plane, the method comprising: locating a heater having a temperature dependent resistance to face the plane of movement of the article; defining an edge in the article
5 between regions of different thermal conductivity; and, detecting variation in resistance of the heater corresponding to variation in heat loss from the heater as the edge moves relative to heater during movement of the article in the plane.

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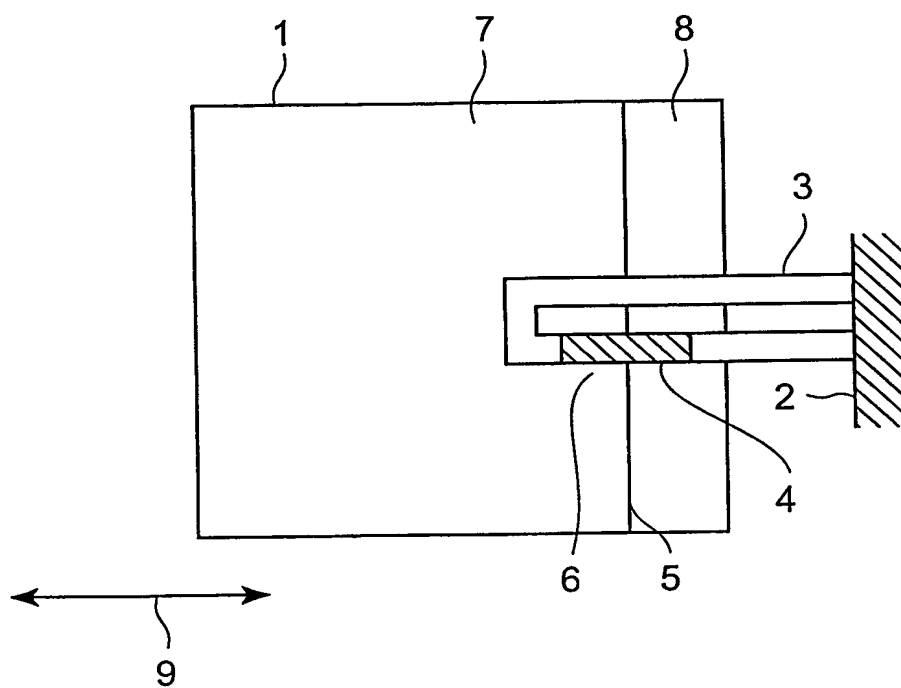


Fig. 1

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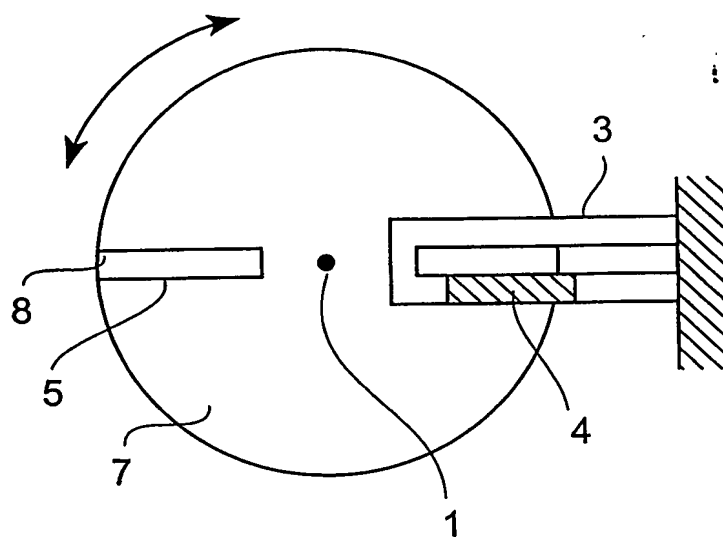


Fig. 2

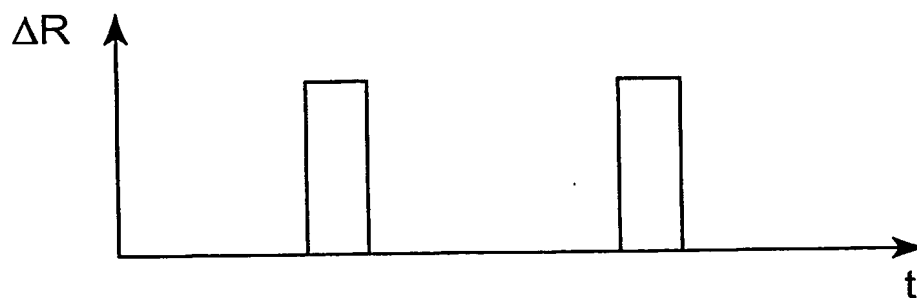


Fig. 3

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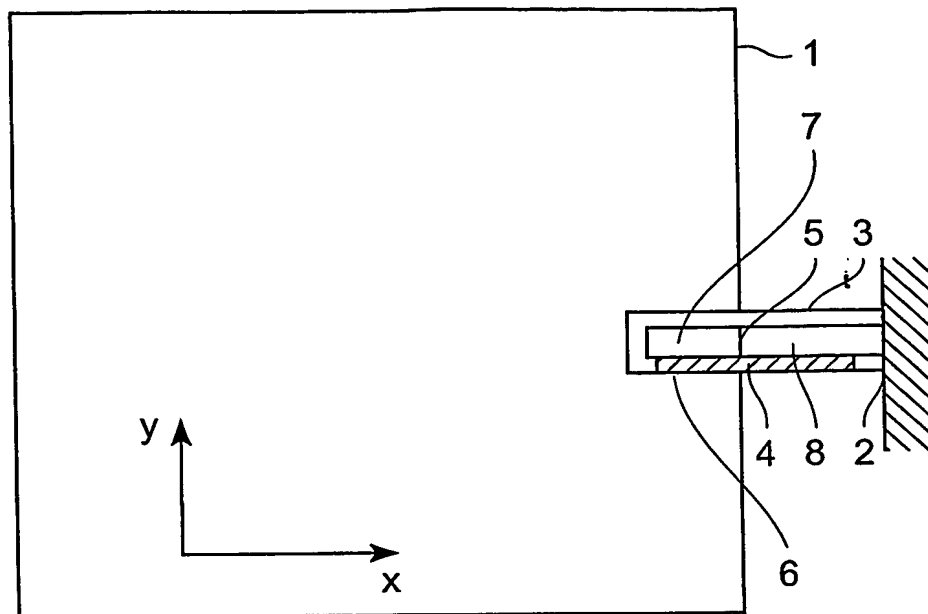


Fig. 4

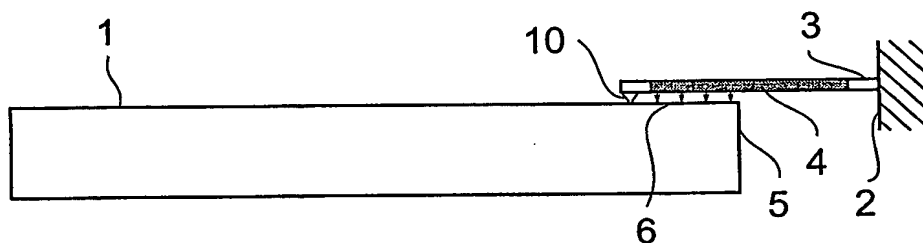


Fig. 5

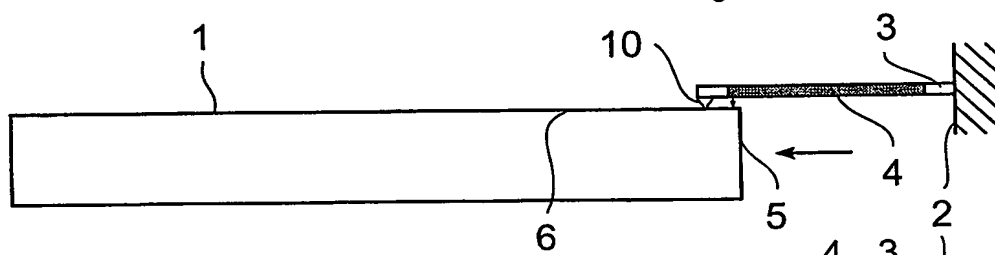


Fig. 6

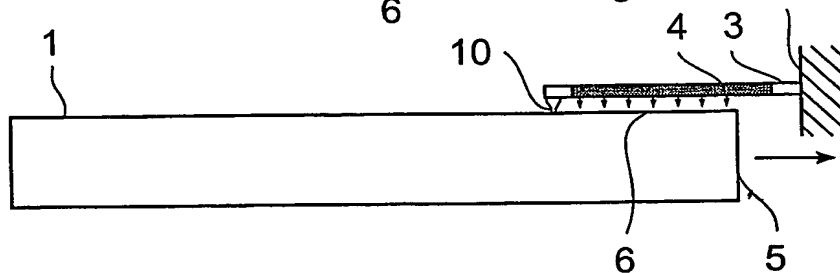


Fig. 7

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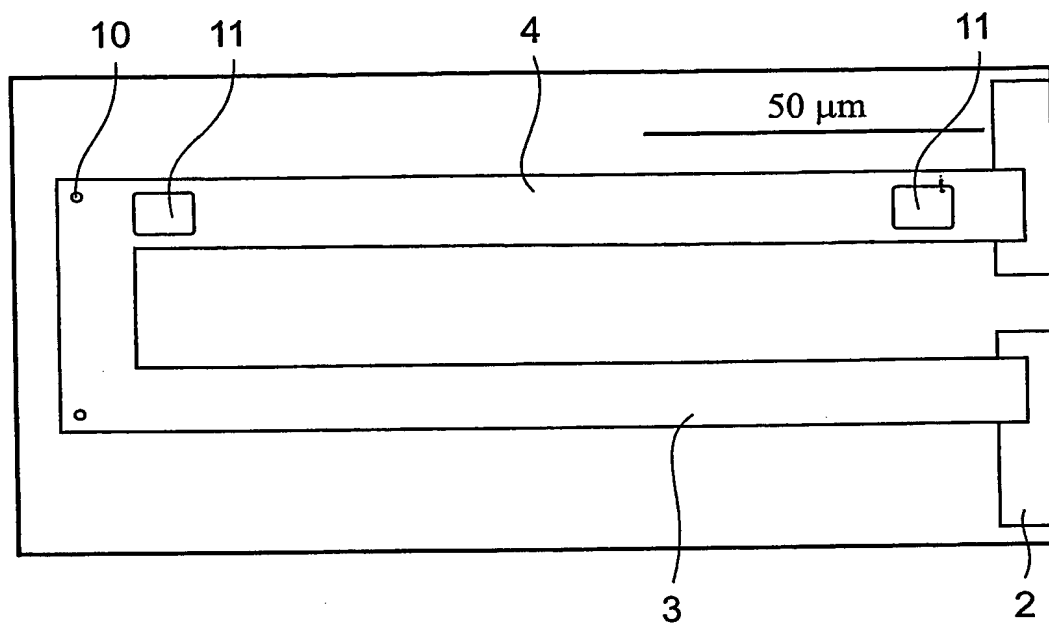


Fig. 8

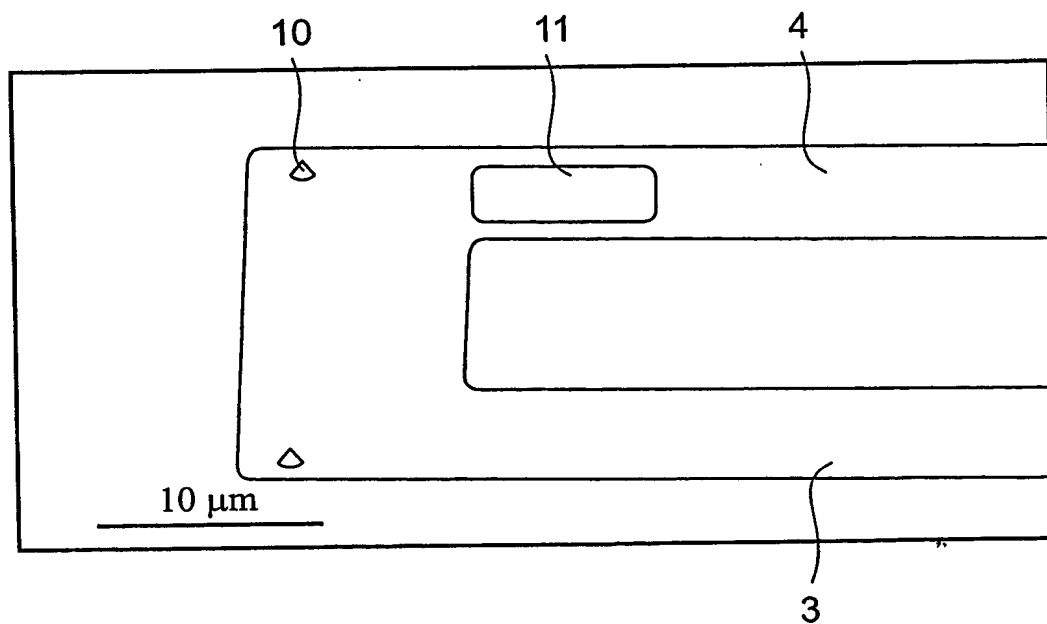


Fig. 9

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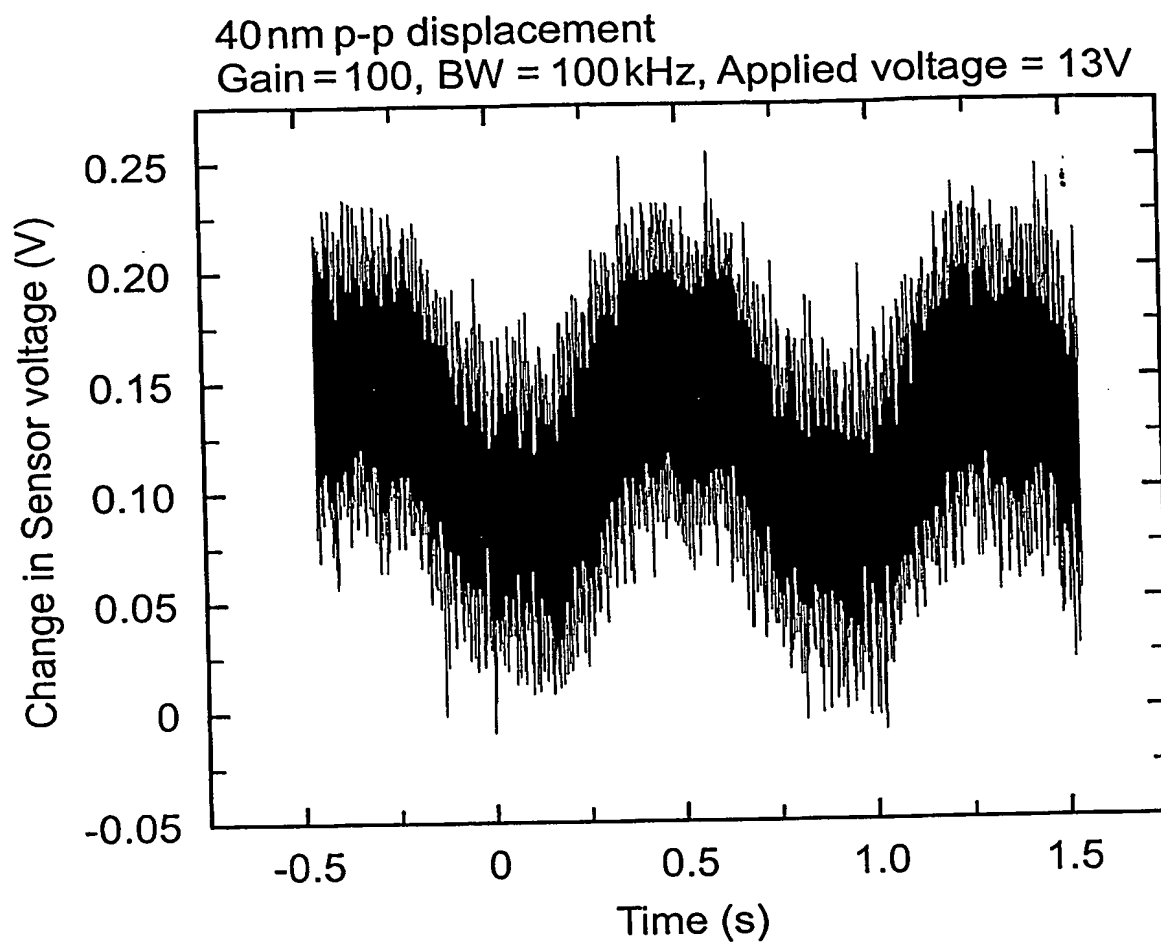


Fig. 10

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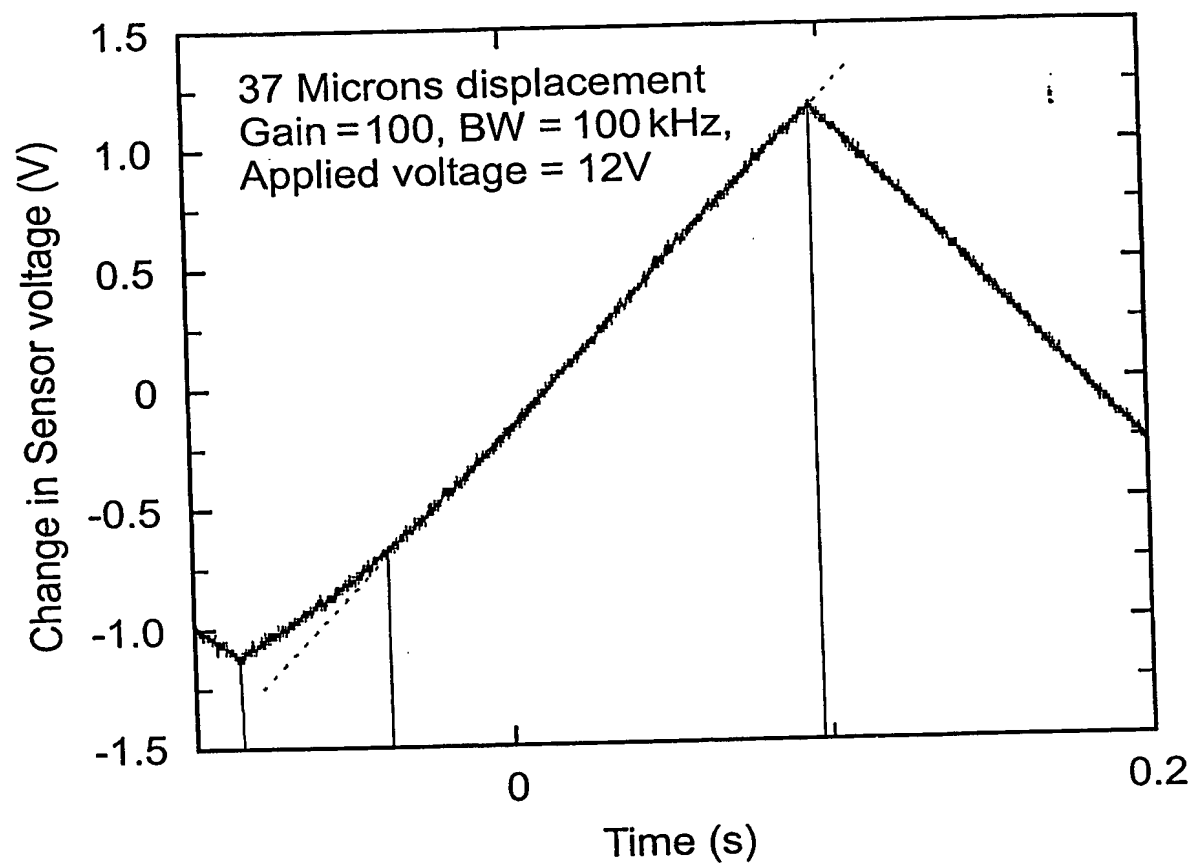


Fig. 11

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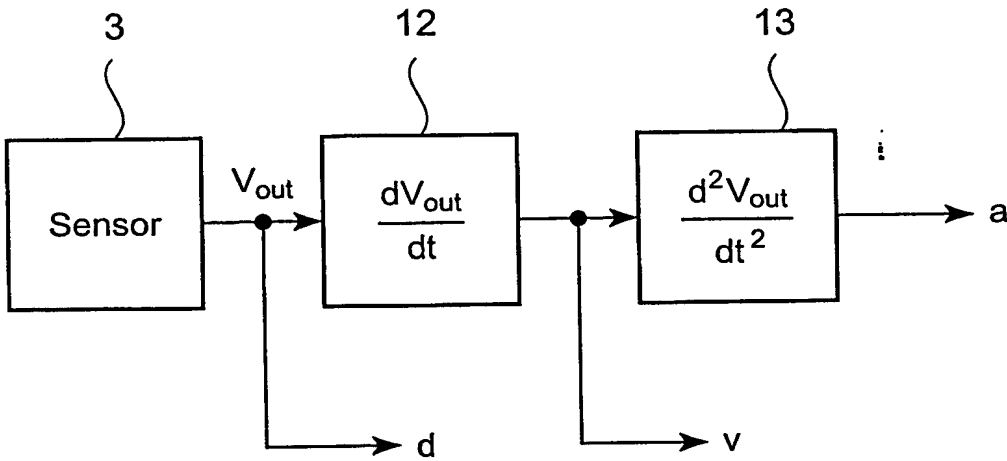


Fig. 12

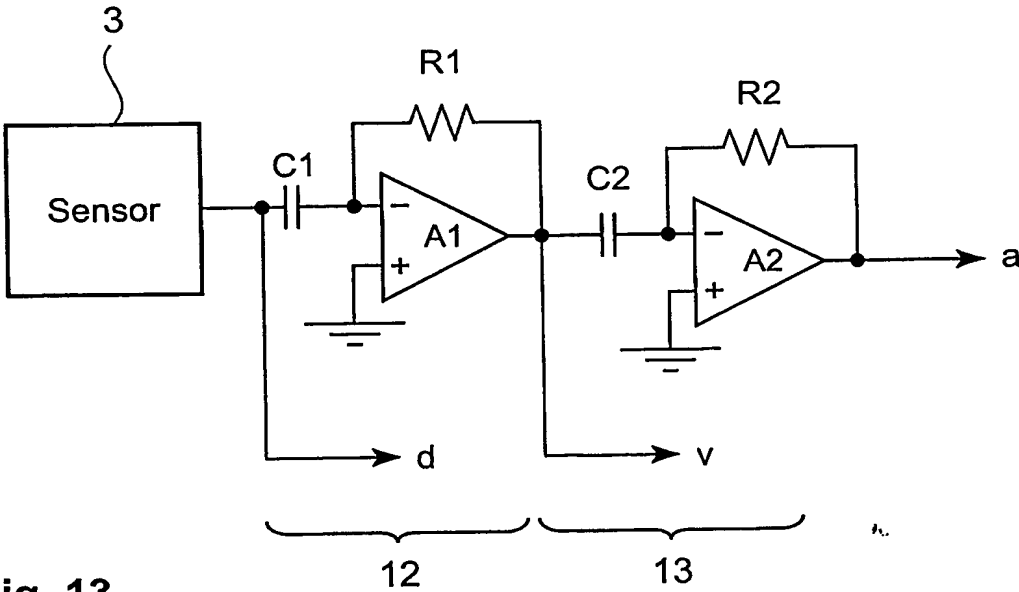


Fig. 13

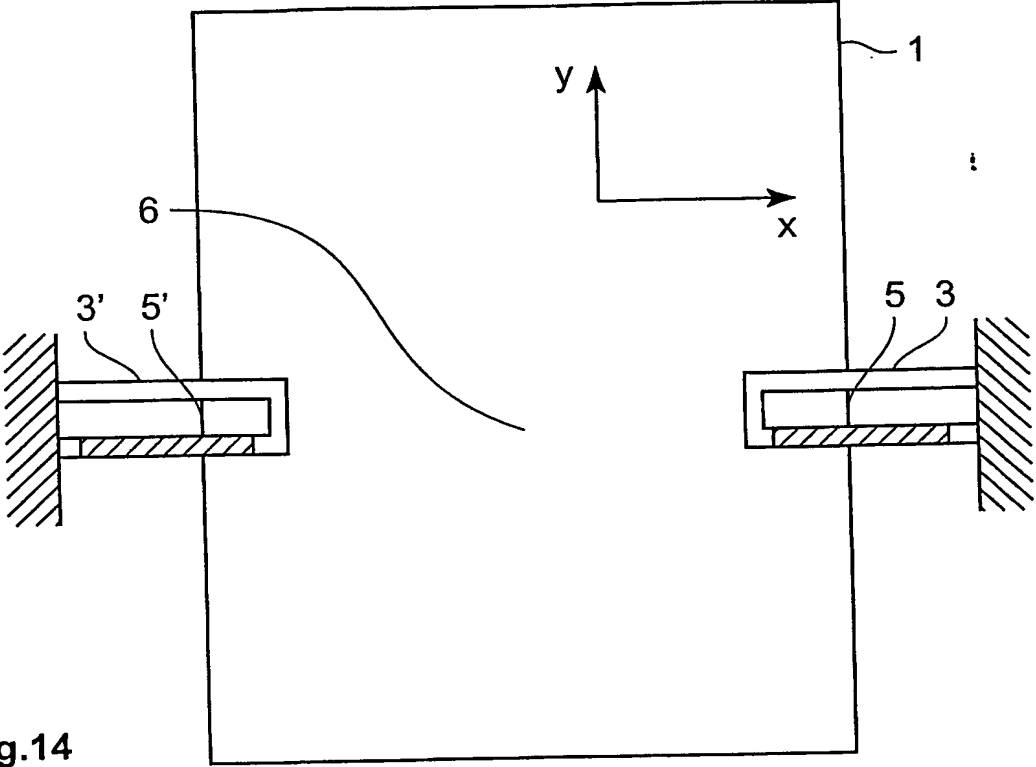


Fig.14

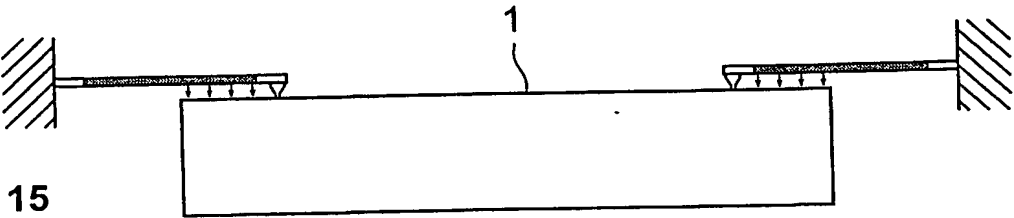


Fig. 15

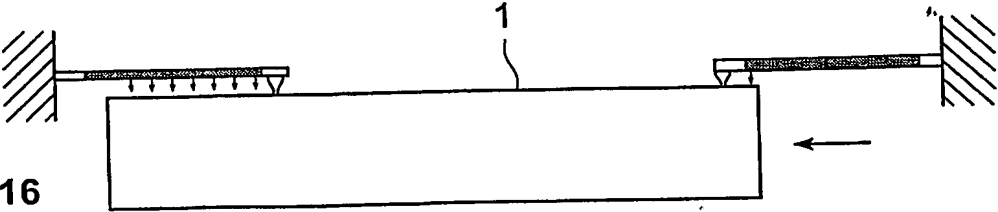


Fig. 16

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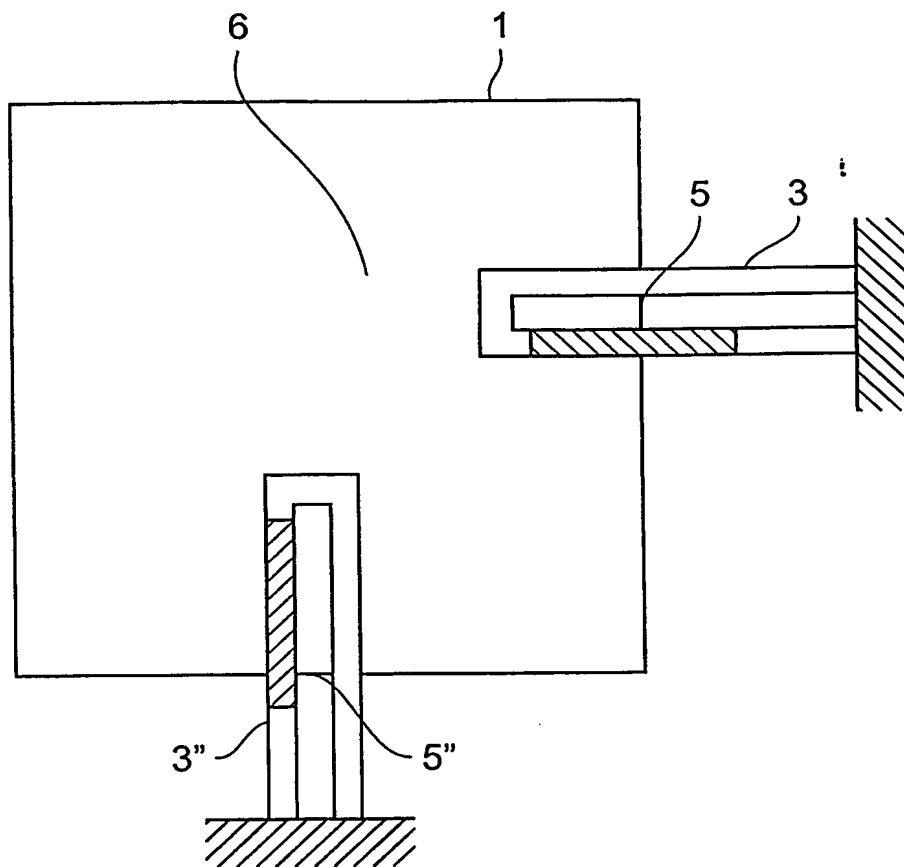


Fig.17

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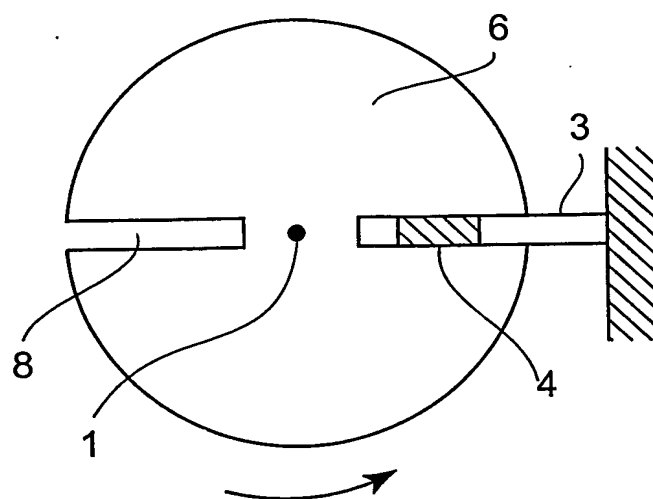


Fig. 17

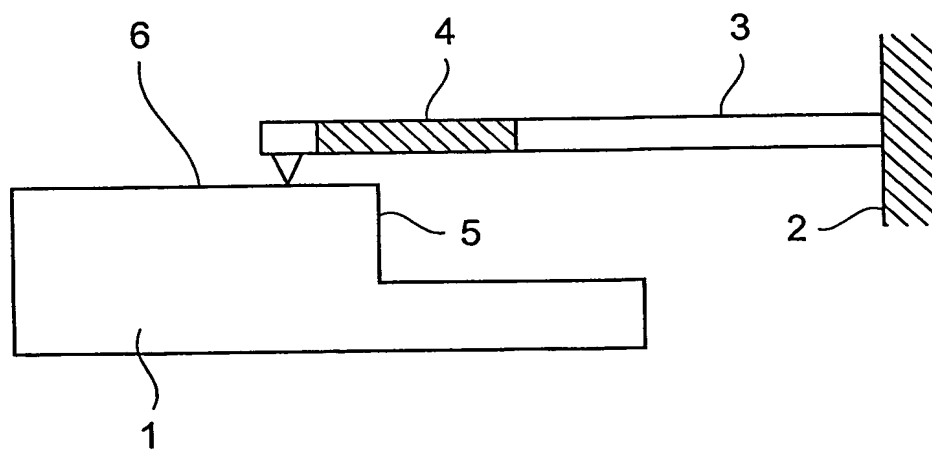


Fig. 18

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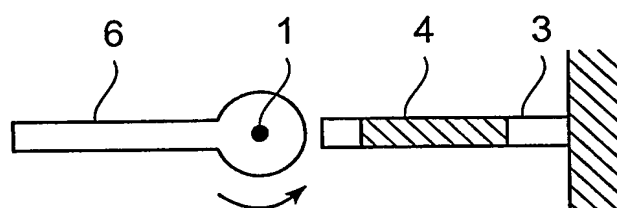


Fig. 20

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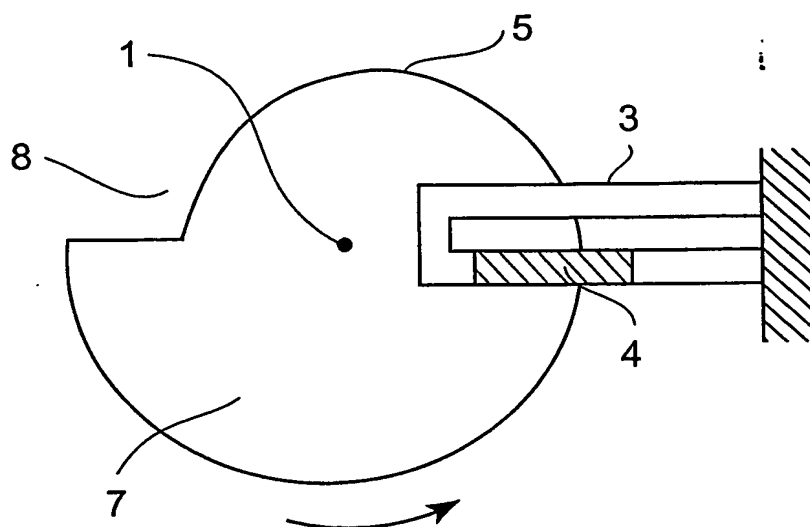


Fig. 21

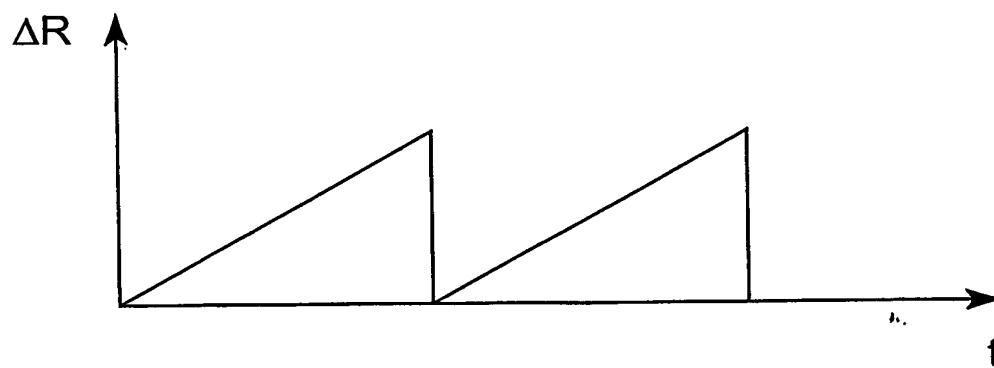


Fig. 22

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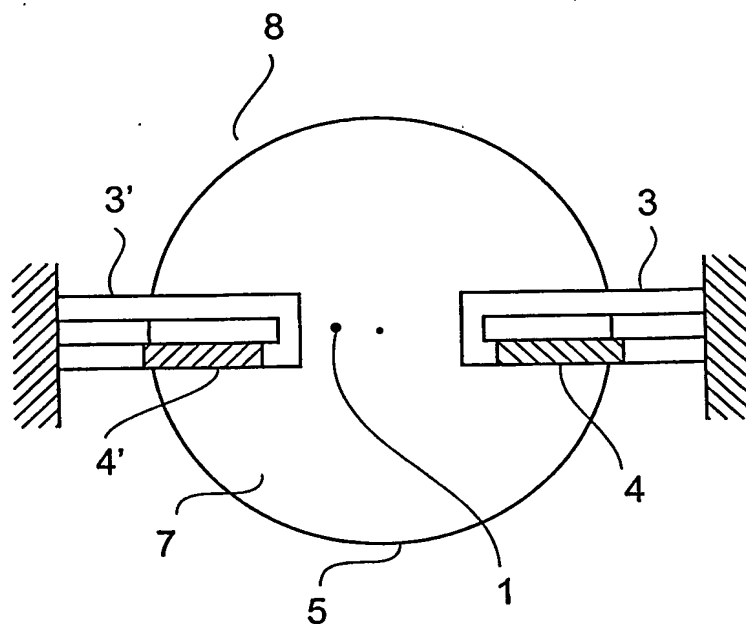


Fig. 23

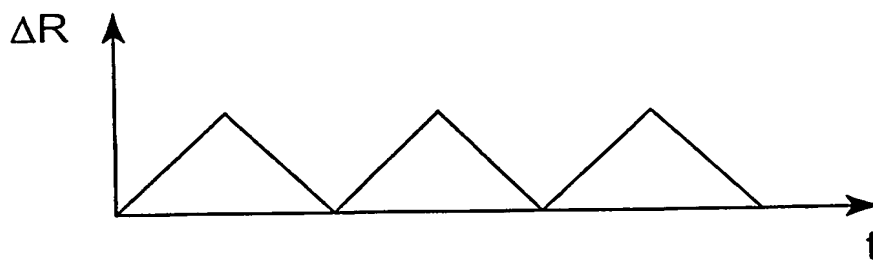


Fig. 24

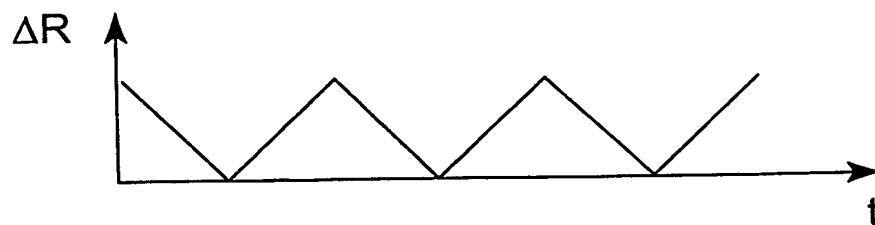


Fig. 25

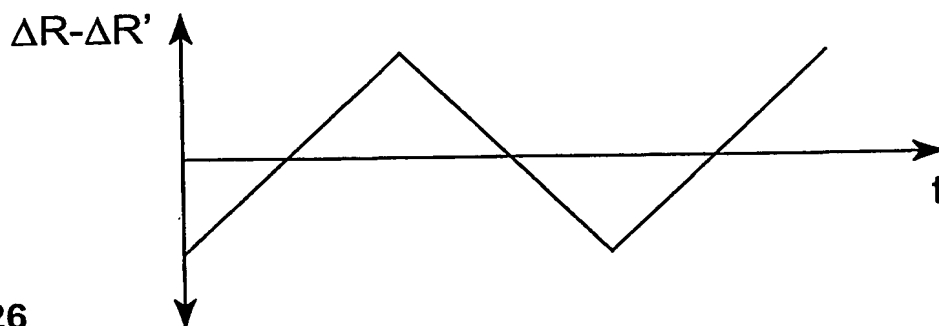


Fig. 26

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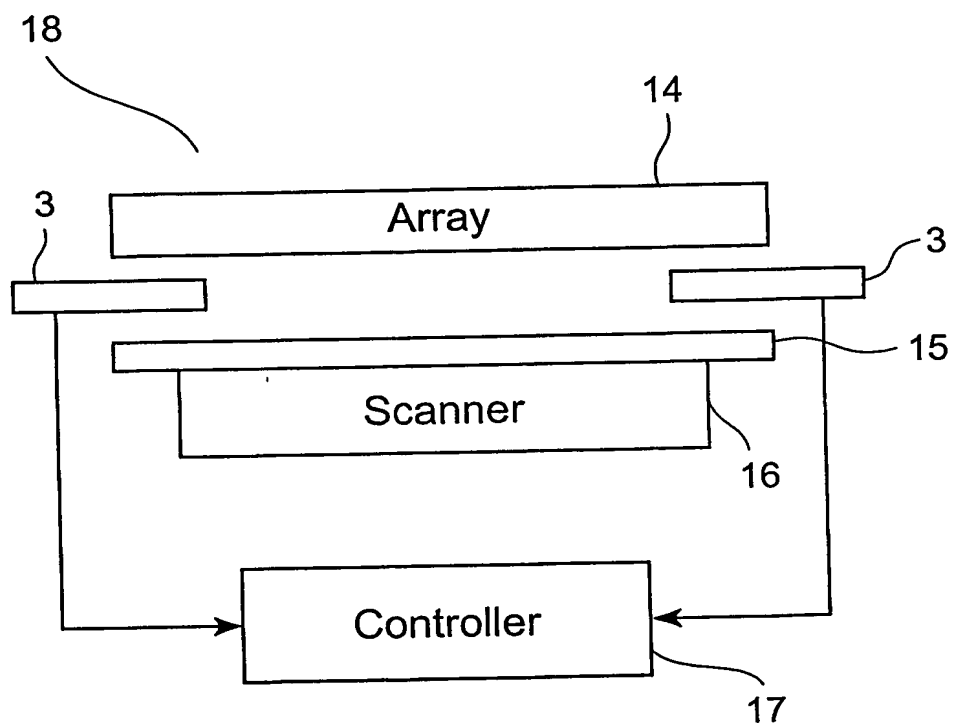


Fig. 27

INTERNATIONAL SEARCH REPORT

 Internati pplication No
 PCT 03/03749

A. CLASSIFICATION OF SUBJECT MATTER

IPC 7 B81B3/00 G12B21/02 G11B9/12

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 B81B G12B G01N G11B

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the International search (name of data base and, where practical, search terms used)

EPO-Internal, INSPEC, WPI Data, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	DESPONT M ET AL: "VLSI-NEMS chip for parallel AFM data storage" SENSORS AND ACTUATORS A, ELSEVIER SEQUOIA S.A., LAUSANNE, CH, vol. 80, no. 2, March 2000 (2000-03), pages 100-107, XP004192095 ISSN: 0924-4247 the whole document	1-17
A	VETTIGER P ET AL: "Ultrahigh density, high-data-rate NEMS-based AFM data storage system" MICROELECTRONIC ENGINEERING, ELSEVIER PUBLISHERS BV., AMSTERDAM, NL, vol. 46, no. 1-4, May 1999 (1999-05), pages 11-17, XP004170659 ISSN: 0167-9317 the whole document	1-17

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Date of the actual completion of the international search

11 December 2003

Date of mailing of the international search report

22/12/2003

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INTERNATIONAL SEARCH REPORT

Internat Application No
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C.(Continuation) DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
A	US 2001/038598 A1 (DRECHSLER UTE ET AL) 8 November 2001. (2001-11-08) the whole document	1-17
A	DAUDERSTADT U A ET AL: "Temperature dependence and drift of a thermal accelerometer" 1997 INTERNATIONAL CONFERENCE ON SOLID-STATE SENSORS AND ACTUATORS. DIGEST OF TECHNICAL PAPERS. TRANSDUCERS 97. CHICAGO, IL, JUNE 16 - 19, 1997. SESSIONS 3A1 - 4D3. PAPERS NO. 3A1.01 - 4D3.14P, INTERNATIONAL CONFERENCE ON SOLID-STATE SENSORS AND ACTU, vol. VOL. 2, 16 June 1997 (1997-06-16), pages 1209-1212, XP010240697 ISBN: 0-7803-3829-4 the whole document	1-17
A	INTERNET ARTICLE, 'Online! vol. 44, no. 3, 2000, XP002264563 Retrieved from the Internet: <URL:http://www.research.ibm.com/journal/r d/443/vettiger.pdf> 'retrieved on 2003-12-10! cited in the application the whole document	1-17

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Patent document cited in search report	Publication date	Patent family member(s)	Publication date
US 2001038598	A1	08-11-2001	NONE